



P-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
	0.0065 at V _{GS} = - 4.5 V	- 14			
- 12	0.00775 at V _{GS} = - 2.5 V	- 13			
	0.01025 at V _{GS} = - 1.8 V	- 12			

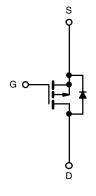
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

COMPLIANT HALOGEN FREE

APPLICATIONS

- · Load Switch
- Battery Switch



P-Channel MOSFET

	SO-8		
S 1 S 2 S 3 G 4		8 7 6 5	D D D
	Top View		

Ordering Information: Si4453DY-T1-E3 (Lead (Pb)-free) Si4453DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unles	ss otherwise r	noted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	- 12		
Gate-Source Voltage		V_{GS}	V _{GS} ± 8		V
Out in the Company of	T _A = 25 °C	1	- 14	- 10	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C	- I _D	- 11.5	- 8	
Pulsed Drain Current		I _{DM}	- 50		Α
Continuous Source Current (Diode Conduction) ^a		I _S	- 2.7	- 1.36	
	T _A = 25 °C	В	3.0	1.5	10/
	0.95	W			
Operating Junction and Storage Temperature Ra	nge	T _J , T _{stq}	- 55	- 55 to 150	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manipana lugation to Applicati	t ≤ 10 s	R_{thJA}	33	42	°C/W
Maximum Junction-to-Ambient ^a	Steady State		70	84	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	16	21	

a. Surface Mounted on 1" x 1" FR4 board.

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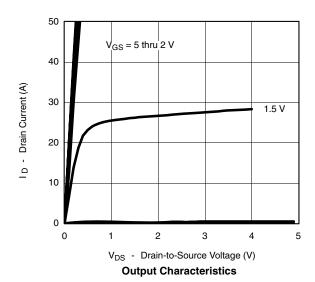
SPECIFICATIONS $T_J = 25$ °	C, unless	otherwise noted					
Parameter	Symbol	Test Conditions	onditions Min. 1		Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -600 \mu A$	- 0.4		- 0.9	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zava Cata Valtaga Drain Current	I _{DSS}	V _{DS} = - 12 V, V _{GS} = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current		V _{DS} = - 12 V, V _{GS} = 0 V, T _J = 70 °C			- 10		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 4.5 V	- 30			Α	
Drain-Source On-State Resistance ^a		V _{GS} = - 4.5 V, I _D = - 14 A		0.0051	0.0065		
	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 13 A	0.0062	0.00775	Ω		
		V _{GS} = - 1.8 V, I _D = - 12 A		0.0082	0.01025		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 6 V, I _D = - 14 A		80		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 2.7 A, V _{GS} = 0 V		- 0.6	- 1.1	V	
Dynamic ^b							
Total Gate Charge	Q_g			110	165		
Gate-Source Charge	Q_{gs}	V _{DS} = -6 V, V _{GS} = -5 V, I _D = -14 A		15		nC	
Gate-Drain Charge	Q_{gd}			27.5			
Turn-On Delay Time	t _{d(on)}			110	170		
Rise Time	t _r	V_{DD} = - 6 V, R_L = 6 Ω		235	350		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 1 A, V_GEN = - 4.5 V, R_g = 6 Ω		410	620	ns	
Fall Time	t _f			285	430		
Gate Resistance	R_g			3.6		Ω	
Source-Drain Reverse Recovery Time t _{rr}		$I_F = -2.1 \text{ A}, dI/dt = 100 \text{ A/}\mu\text{s}$		180	270	ns	

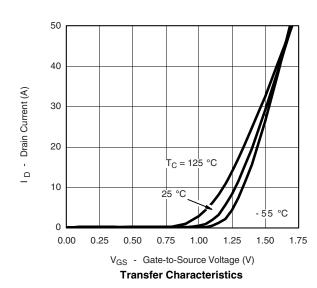
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C unless otherwise noted

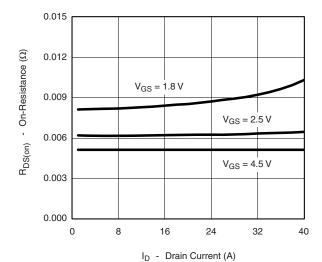




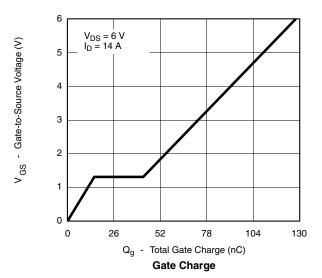


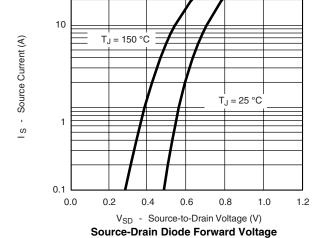


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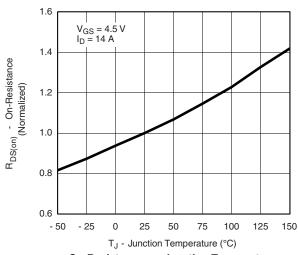
On-Resistance vs. Drain Current



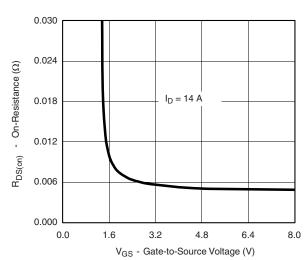


12000 10000 C - Capacitance (pF) 8000 6000 C_{oss} 4000 $\mathsf{C}_{\mathsf{rss}}$ 2000 0 0 2 4 6 8 10 12

V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature



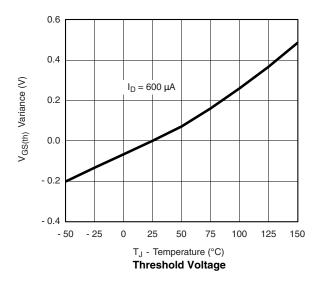
On-Resistance vs. Gate-to-Source Voltage

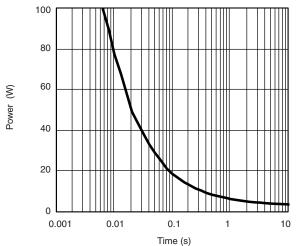
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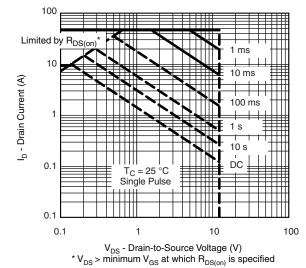
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TYPICAL CHARACTERISTICS 25 °C unless otherwise noted

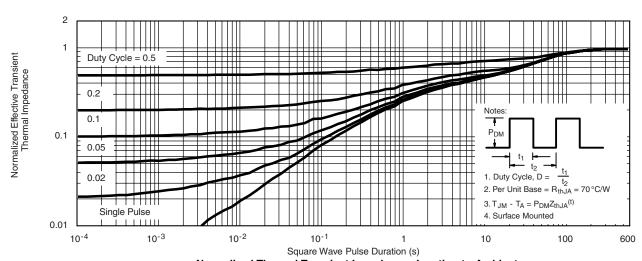




Single Pulse Power, Junction-to-Ambient



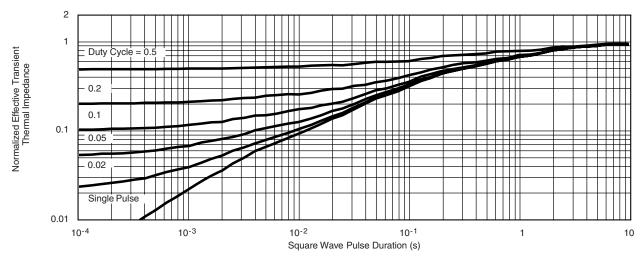
Safe Operating Area, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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